



Product Change Notification

Change Notification #: 814952-00

Change Title: Select Intel® Server System S2600WF Family,
PCN 814952-00, Product Design,
FXX25HSCAR3 Hard Drive Carrier update

Date of Publication: February 01, 2024

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:*	February 20, 2024
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the items listed in the “Products Affected” table:

Inclusion of improved FXX25HSCAR3 Hard Drive Carrier which mitigates potential damage to 2.5” Hot Swap Backplanes (HSBP) of select Intel® Server System S2600WF Family products. The improved carrier FXX25HSCAR3, is only included in Intel® Server System S2600WF Family integrated with the 2.5” Hot Swap Backplanes. This change is not applicable to any other products.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Server System R2208WFQZSR	R2208WFQZSR	986055	K40017-005	K40017-006
Intel® Server System R2208WF0ZSR	R2208WF0ZSR	986050	K39997-015	K39997-016
Intel® Server System R1208WFTYSR	R1208WFTYSR	986007	K39975-020	K39975-021
Intel® Server System R2208WFTZSR	R2208WFTZSR	986049	K39991-019	K39991-020

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
February 01, 2024	00	Originally Published PCN



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No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

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Asia Pacific/PRC Contact: apacgccb@intel.com

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